10/670,292

Ref .	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S1	19640	(heat adj sink) and (chip ic)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/27 18:11
S2	16359	(heat adj sink) and (chip (itegrated adj circuit))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/27 18:11
S3	2667	S2 and fluid	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF ·	2005/04/27 18:12
S4	. 1992	S3 and cooling	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/27 18:12
S5	745	S4 and (pcb (circuit adj board))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/27 18:12
S6	387	S5 and volume	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/28 11:02
S12	0	liquid adj filled adj (heatsink (heat adj sink))	JPO	OR	OFF	2005/04/28 15:13
S13	5	liquid adj filled adj (heatsink (heat adj sink))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/28 15:14
S14	31	liquid adj filled near3 (heatsink (heat adj sink))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/28 15:26